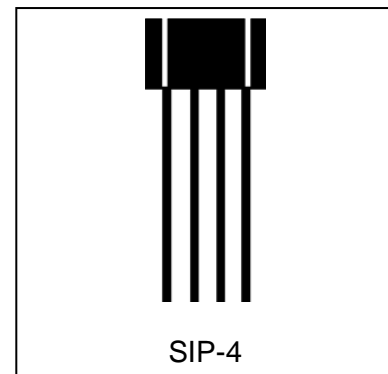


High Sensitivity Differential Speed Sensor IC CYGTS9625

The differential Hall Effect Gear Tooth sensor CYGTS9625 provides a high sensitivity and a superior stability over temperature and symmetrical thresholds in order to achieve a stable duty cycle. CYGTS9625 is particularly suitable for rotational speed detection and timing applications of ferromagnetic toothed wheels such as anti-lock braking systems, transmissions, crankshafts, etc. The integrated circuit, which is based on Hall Effect principle, is response to changing differential magnetic fields created by rotating ring magnets and by ferrous targets when coupled with a magnet and provides a digital signal output with frequency proportional to the rotational speed. The device is packaged in a 4-pin plastic SIP. It is lead (Pb) free, with 100% matte tin plated lead frame.

Features

- Integrated filter capacitor
- South and North pole pre-induction possible
- Large air gap
- 3.8V to 24V supply operating range
- Wide operating temperature range -40°C ~150°C
- Output compatible with both TTL and CMOS logic families
- Protection against over-voltage in all PIN
- Reverse-current protection in power supply V_{DD} PIN
- Output protection against electrical disturbances



Applications

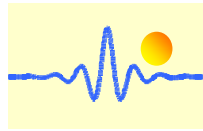
Automotive and Heavy Duty Vehicles	Industrial Areas:
<ul style="list-style-type: none"> • Camshaft and crankshaft speed and position • Transmission speed • Tachometers • Anti-skid/traction control 	<ul style="list-style-type: none"> • Sprocket speed • Chain link conveyor speed/distance • Stop motion detector • High speed low cost proximity • Tachometers, counters.

Device Information

Part number	Packing	Mounting	Temperature range	Marking
CYGTS9625VB	Bulk, 500pcs/bag	4-pin SIP	-40°C~150°C	9625

Operating Range

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Back Bias Range	B_{Bias}	Operating	-500	--	500	mT
Differential Magnetic Field	ΔB	$f=1kHz$	-100	--	100	mT
Supply Voltage	V_{DD}	Operating	3.8	12	24	V
Operating Temperature	T_A		-40	~	150	°C
Storage Temperature	T_S		-65	~	175	°C



Electrical and Magnetic Specifications

Operating Parameters $T_A = -40^{\circ}\text{C}$ to 150°C , $V_{DD} = 12\text{V}$ (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ.	Max	Unit
Supply Voltage	V_{DD}	Operating	3.8	12	24	V
Supply Current	I_{DD}	$V_{DD}=3.8$ to 24V	2.5	3.5	4.5	mA
Output Saturation Voltage	V_{sat}	$I_{out}=20\text{mA}$, $T_A=25^{\circ}\text{C}$	--	150	400	mV
Output Leakage Current	I_{Leak}	$V_{out}=24\text{V}$	--	--	10	μA
Overvoltage protection at supply voltage	V_{SP}	$I_{DD} = 10\text{mA}$	30	35	40	V
Overvoltage protection at output terminal	V_{OP}	$I_{out}=1\text{mA}$, $V_{out}=\text{High}$	30	35	40	V
Over current protection	OCP ¹	$T_A=25^{\circ}\text{C}$	40	--	--	mA
Power on time	t_{po} ²	$V_{DD} > 3.8\text{V}$	--	3.8	9.0	ms
Settling time	t_{settle} ³	$V_{DD}>3.8\text{V}$, $f=1\text{kHz}$	0	--	50	ms
Response time	$t_{response}$ ⁴	$V_{DD}>3.8\text{V}$, $f=1\text{kHz}$	3.8	--	59	ms
Output Rise Time	T_R ⁵	$R1=1\text{k}\Omega$ $C=20\text{pF}$	--	--	0.2	μs
Output Fall Time	T_F	$R1=1\text{k}\Omega$ $C=20\text{pF}$	--	--	0.2	μs
Upper corner frequency	f_{cu}	-3dB, single pole	20	--		kHz
Lower corner frequency	f_{cl}	-3dB, single pole	--	--	10	Hz
Back Bias Range	B_{Bias}	Operating	-500		500	mT
Differential Magnetic Field	ΔB ⁶	$f=1\text{kHz}$	-100		100	mT
Output on switch point	Bop	$f=1\text{kHz}$, $\Delta B=5\text{mT}$	--	--	0	mT
Output off switch point	Boff	$f=1\text{kHz}$, $\Delta B=5\text{mT}$	0	--	--	mT
Positive and negative hysteresis	B_{HYS}	$f=1\text{kHz}$, $\Delta B=5\text{mT}$	0.4	1.2	2.0	mT

1 I_{OUT} does not change state when $I_{OUT}=OCP$.

2 Time required initializing device.

3 Time required for the output switch points to be within specification.

4 Equal to $t_{po} + t_{settle}$.

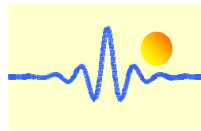
5 Output Rise Time will be dominated by the RC time constant.

6 Exceeding this limit might result in decreased duty cycle performance and the phase accuracy.

Absolute Maximum Ratings

Parameter	Symbol	Minimal value	Maximal value	Unit
Power supply voltage	V_{DD}	-30	30	V
Power output current	I_{DD}	-10	25	mA
Output terminal voltage	V_{OUT}	-0.5	30	V
Output terminal current sink	I_{SINK}	0	40	mA
Operating ambient temperature	T_A	-40	150	$^{\circ}\text{C}$
Maximum junction temperature	T_J	-55	165	$^{\circ}\text{C}$
Storage temperature	T_{STG}	-65	175	$^{\circ}\text{C}$

Note: Stresses above those listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



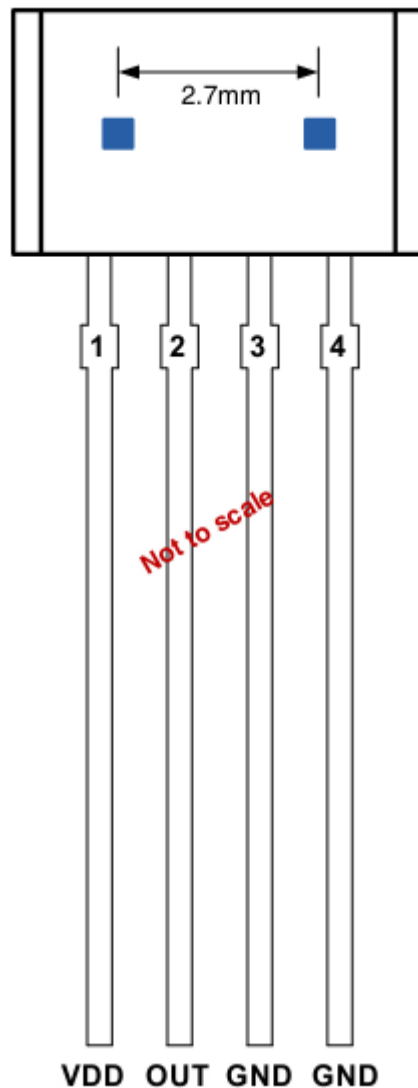
ESD (Emergency Shutdown System) Protection

Human Body Model (HBM) Tests

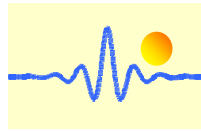
Parameter	Symbol	Max.	Unit	Note
ESD	V_{ESD}	± 4.0	kV	According to Standard EIA/JESD22-A114-B-HBM

Pin Configuration

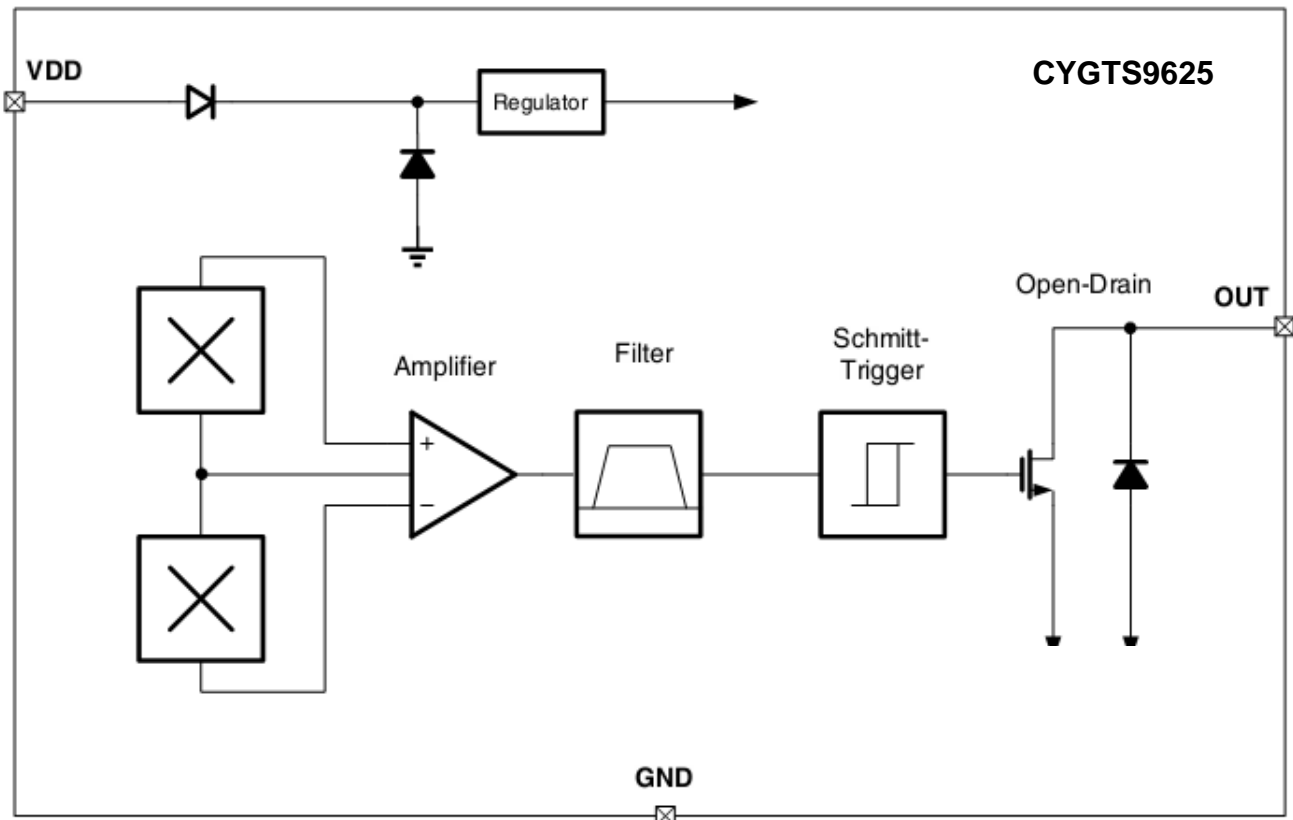
4-Terminal SIP VB package (Top View)



Pin No.	Symbol	Type	Description
1	V_{DD}	Supply voltage	3.8V to 24V power supply
2	OUT	Output	Open-drain output required a pull-up resistor
3	GND	Ground	Ground terminal
4	GND	Ground	Ground terminal



Functional Block Diagram

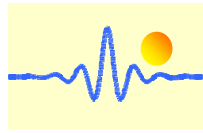


Functional Description

The Differential Hall Sensor IC detects the motion and position of ferromagnetic and permanent magnet structures by measuring the differential flux density of the magnetic field. Changes in field strength at the device face, which are induced by a moving target, are sensed by the two integrated Hall probes. The probes generate signals that are differentially amplified by on-chip electronics. This differential design provides immunity to radial vibration within the operating air gap range of the CYGTS9625, by rejection of the common mode signal. Steady-state magnet and system offsets are eliminated using an on-chip differential band-pass filter. This filter also provides relative immunity to interference from electromagnetic sources.

The device utilizes advanced temperature compensation for the band-pass filter, sensitivity, and Schmitt trigger switch-points to guarantee optimal operation over a wide range of air gaps and temperatures even at lower frequency.

The CYGTS9625 can be exploited to detect toothed wheel rotation in a rough environment. Jolts against the toothed wheel and ripple have no influence on the output signal. Furthermore, the device can be operated in a two-wire as well as in a three wire-configuration.

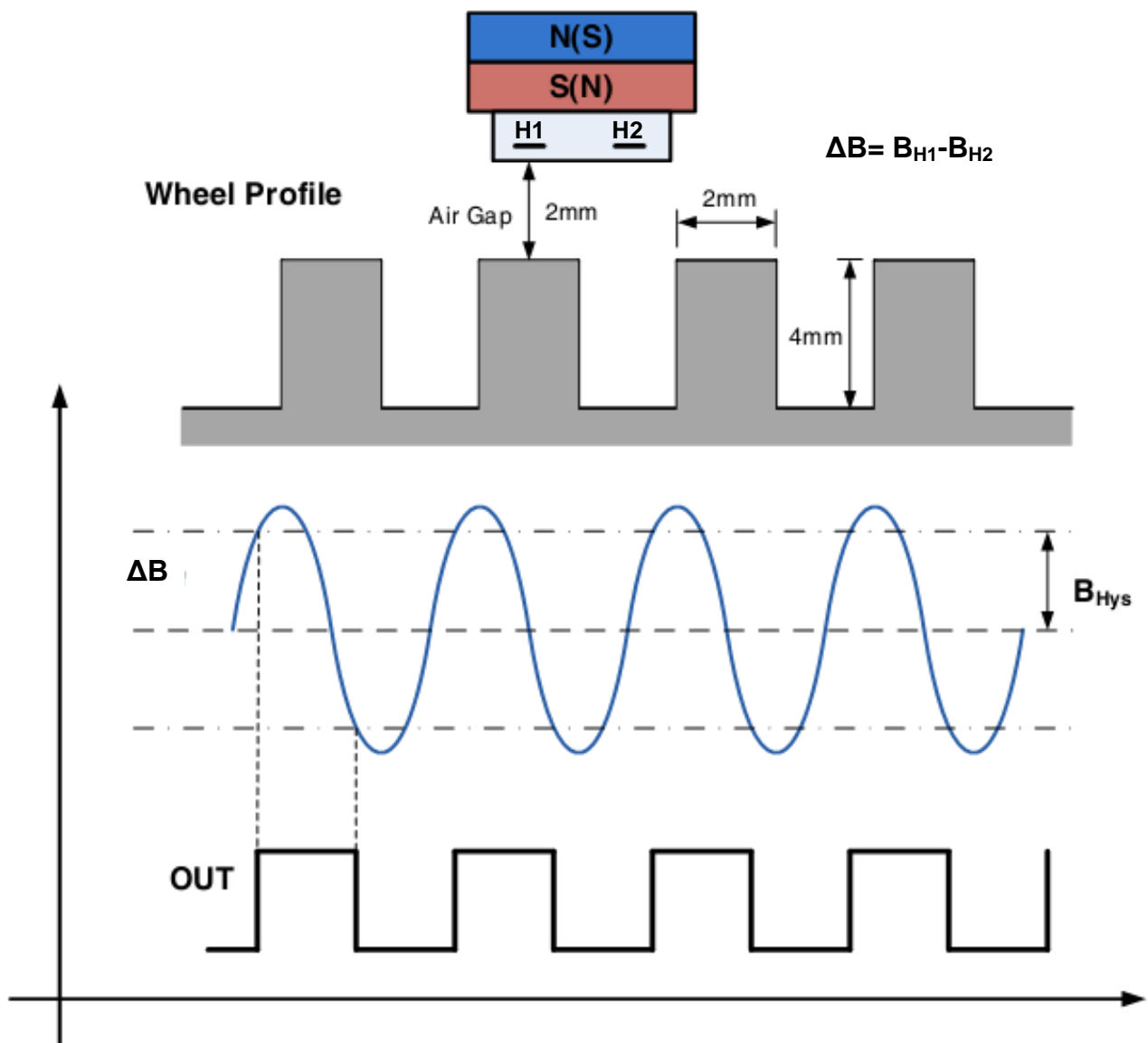


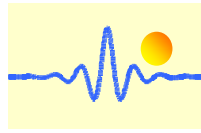
Gear Tooth Sensing

In the case of ferromagnetic toothed wheel application the IC has to be biased by the South or North Pole of a permanent magnet which should cover both Hall probes

The maximum air gap depends on

- the magnetic field strength (magnet used; pre-induction), and
- the toothed wheel that is used (dimensions, material, etc.)

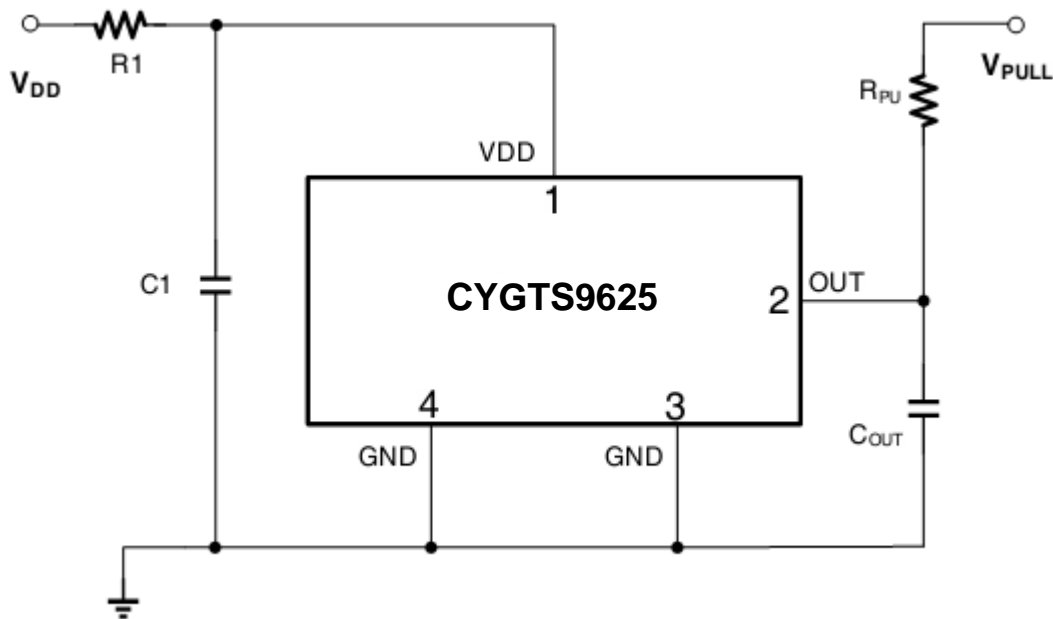




Recommended Application

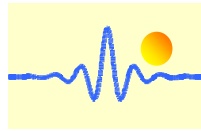
The CYGTS9625 contains an on-chip voltage regulator and can operate over a wide supply voltage range. In applications that operate the device from an unregulated power supply, transient protection must be added externally. For applications using a regulated line, EMI/RFI protection may still be required.

Three-Wire Connection



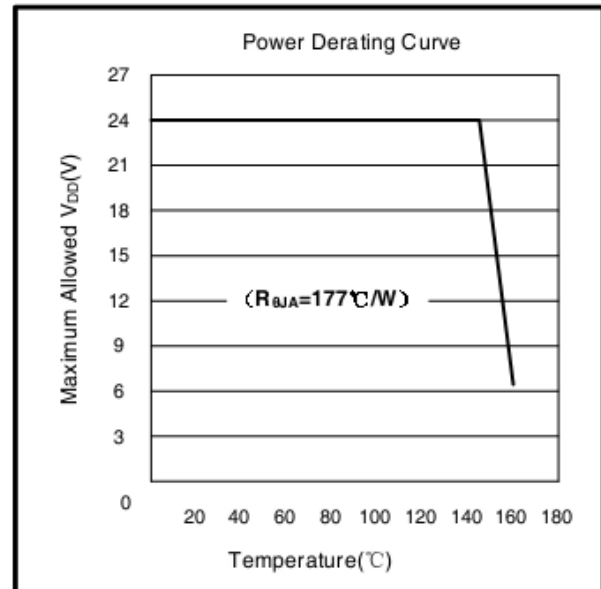
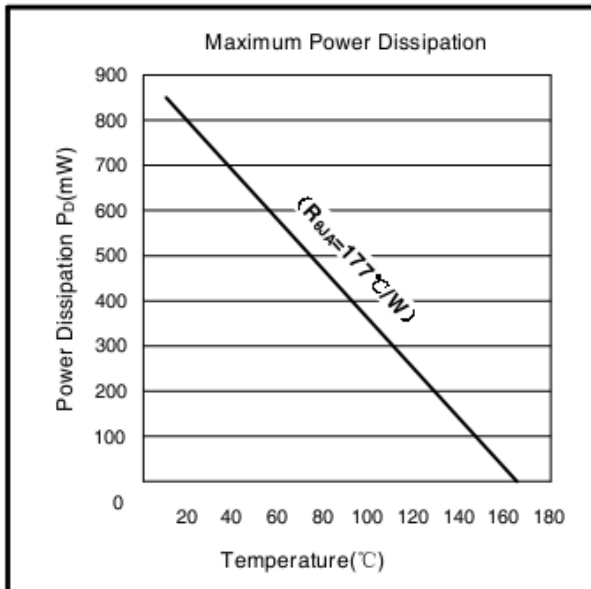
Component	Value	Units
R _{PU}	1.2	kΩ
R1	200	Ω
C1	0.1	μF
C _{OUT}	1.0	μF

1. Pull-up resistor not required for protection but for normal operation
2. R1 is for improved CI performance
3. C_{OUT} is for improved BCI performance



Thermal Characteristics

Symbol	Parameter	Test Conditions	Rating	Units
R _{QJA}	VB Package thermal resistance	Single-layer PCB, with copper limited to solder pads	177	°C/W



Power Derating Description

The device must be operated below the maximum junction temperature of the device, $T_{J(max)}$. Under certain combinations of peak condition, reliable operation may require derating supplied power or improving the heat dissipation properties of the application. The package Thermal Resistance, $R_{\theta JA}$, is figure of merit summarizing the ability of the application and device to dissipate heat from the junction, through all paths to the ambient air. Its primary component is an Effective Thermal Conductivity, K , of the printed circuit board, including adjacent devices and traces. Radiation from the die through the device case, $R_{\theta JC}$, is relatively small component of $R_{\theta JA}$. Ambient air temperature, T_A , and air motion are significant external factors, damped by over molding.

The effect of varying power levels (Power Dissipation, P_D), can be estimated. The following formulas represent the fundamental relationships used to estimate T_J , at P_D .

$$P_D = V_{DD} \times I_{DD} \quad (1)$$

$$\Delta T = P_D \times R_{\theta JA} \quad (2)$$

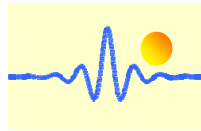
$$T_J = T_A + \Delta T \quad (3)$$

For example $T_A = 25^\circ\text{C}$, $V_{DD} = 12\text{V}$, $I_{DD} = 3.5\text{mA}$, $R_{\theta JA} = 177^\circ\text{C/W}$, we get

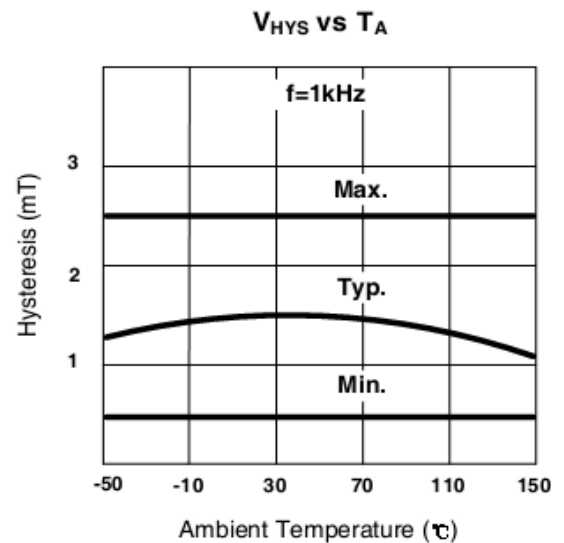
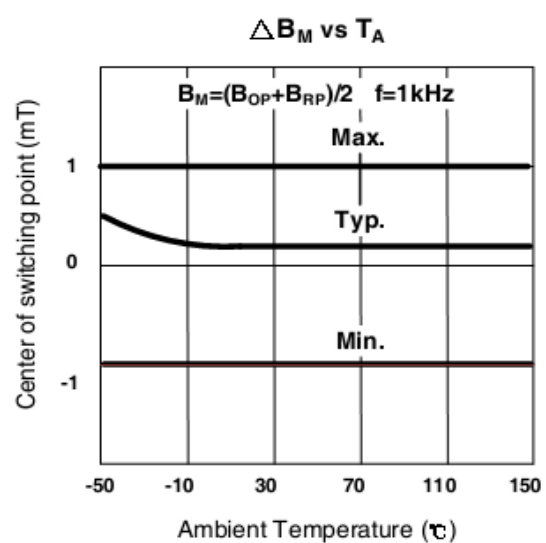
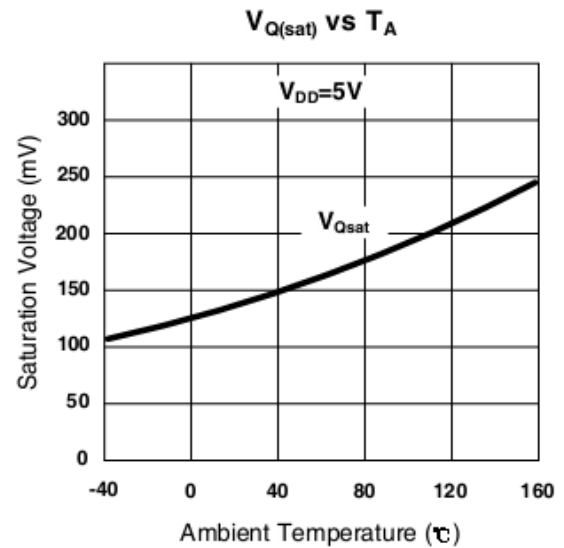
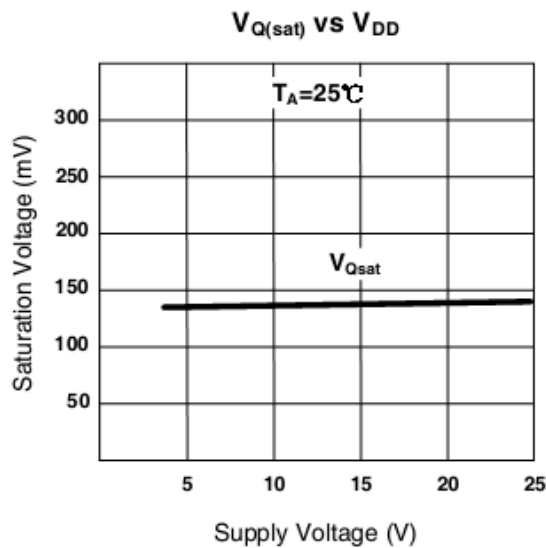
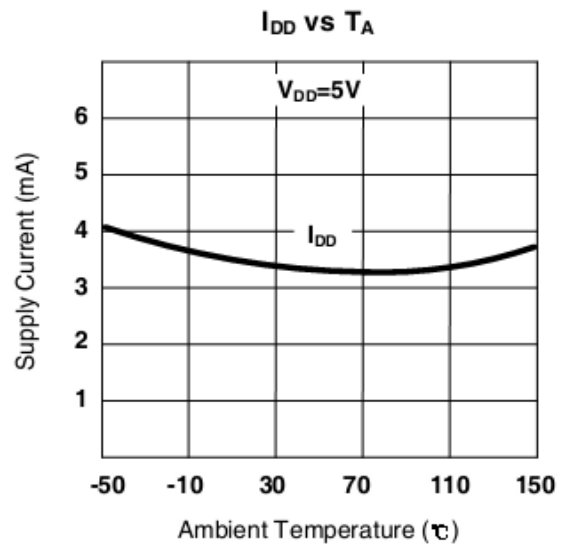
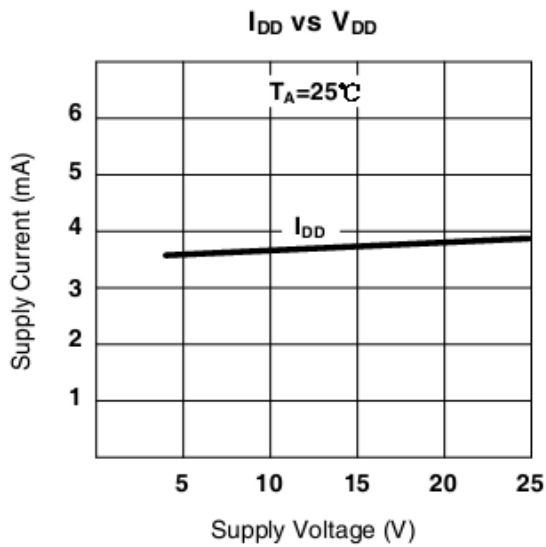
$$P_D = V_{DD} \times I_{DD} = 12\text{V} \times 3.5\text{mA} = 42\text{mW}$$

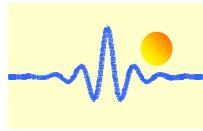
$$\Delta T = P_D \times R_{\theta JA} = 42\text{mW} \times 177^\circ\text{C/W} = 7.5^\circ\text{C}$$

$$T_J = T_A + \Delta T = 25^\circ\text{C} + 7.5^\circ\text{C} = 32.5^\circ\text{C}$$



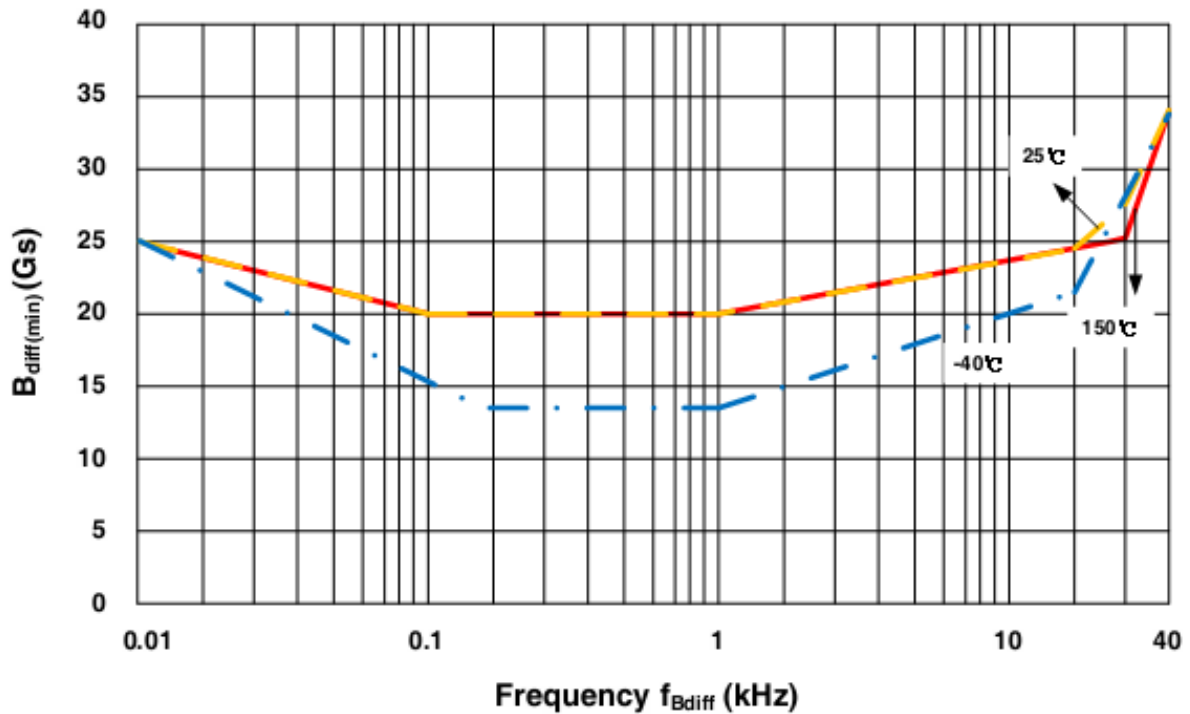
Empirical Result



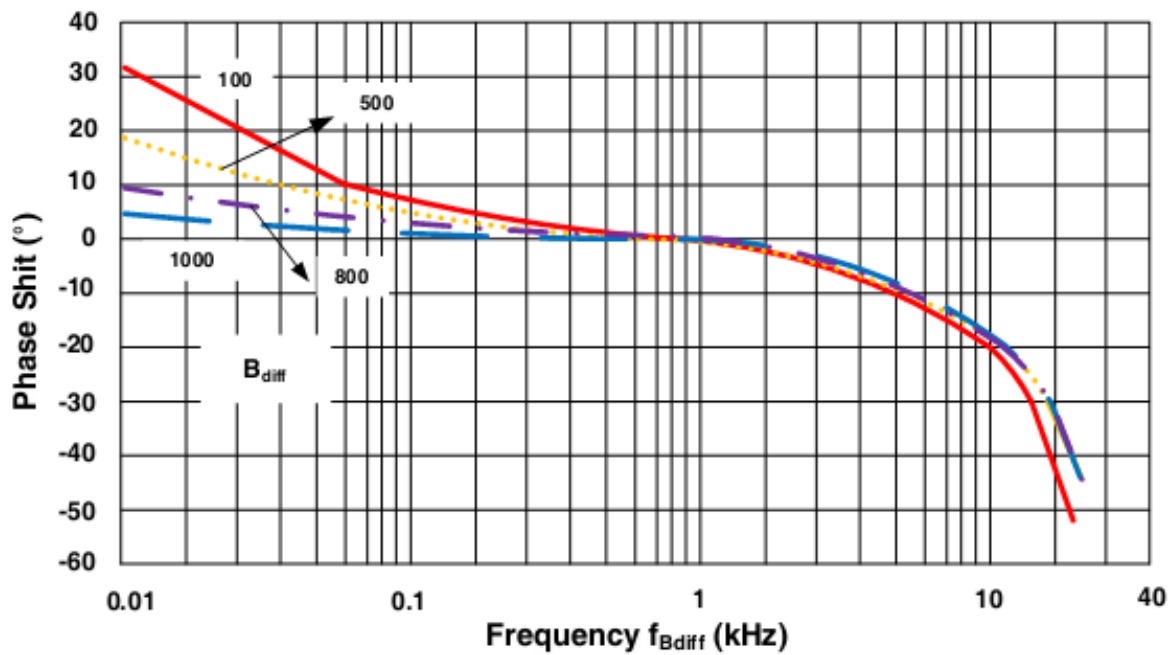


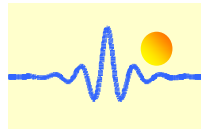
Simulation Result

Minimum Switch Fields versus Frequency



Typical Phase Shift versus Frequency

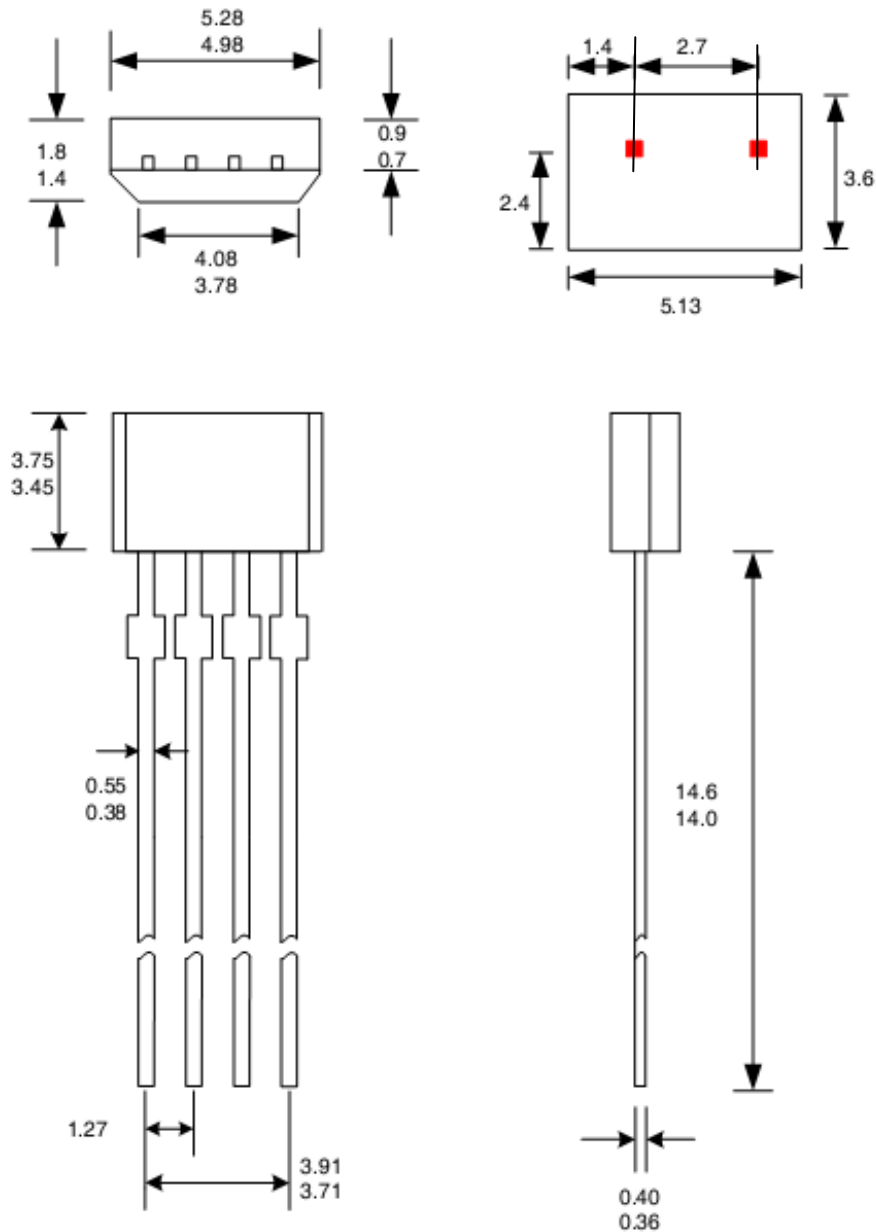




Package Designator

4-Terminal VB Package

Dimension:mm



Notes:

1. Exact body and lead configuration at vendor's option within limits shown.
2. Height does not include mold gate flash.
Where no tolerance is specified, dimension is nominal.